

# Hyper Mini TOPLED®

## Hyper-Bright LED

LB M673, LV M673, LT M673



### Vorläufige Daten / Preliminary Data

#### Besondere Merkmale

- **Gehäusotyp:** weißes SMT Gehäuse
- **Besonderheit des Bauteils:** kleine Bauform für Anwendungen mit wenig Platzbedarf
- **Wellenlänge:** 470 nm (blau), 505 nm (verde), 528 nm (true green)
- **Abstrahlwinkel:** Lambertscher Strahler (120°)
- **Technologie:** InGaN
- **optischer Wirkungsgrad:** 2 lm/W (blau), 6 lm/W (verde), 8 lm/W (true green)
- **Gruppierungsparameter:** Lichtstärke, Wellenlänge
- **Verarbeitungsmethode:** für alle SMT-Bestücktechniken geeignet
- **Lötmethode:** IR Reflow Löten und Wellenlöten (TTW)
- **Vorbehandlung:** nach JEDEC Level 2
- **Gurtung:** 8 mm Gurt mit 3000/Rolle, ø180 mm oder 12000/Rolle, ø330 mm
- **ESD-Festigkeit:** ESD-sicher bis 2 kV nach EOS/ESD-5.1-1993

#### Anwendungen

- Informationsanzeigen im Außenbereich
- optischer Indikator
- Hinterleuchtung (LCD, Schalter, Tasten, Displays, Werbebeleuchtung, Allgemeinbeleuchtung)
- Innenbeleuchtung im Automobilbereich (z.B. Instrumentenbeleuchtung, u. ä.)
- Markierungsbeleuchtung (z.B. Stufen, Fluchtwege, u.ä.)
- Signal- und Symbolleuchten

#### Features

- **package:** white SMT package
- **feature of the device:** small package for applications where small space is required
- **wavelength:** 470 nm (blue), 505 nm (verde), 528 nm (true green)
- **viewing angle:** Lambertian Emitter (120°)
- **technology:** InGaN
- **optical efficiency:** 2 lm/W (blue), 6 lm/W (verde), 8 lm/W (true green)
- **grouping parameter:** luminous intensity, wavelength
- **assembly methods:** suitable for all SMT assembly methods
- **soldering methods:** IR reflow soldering and TTW soldering
- **preconditioning:** acc. to JEDEC Level 2
- **taping:** 8 mm tape with 3000/reel, ø180 mm or 12000/reel, ø330 mm
- **ESD-withstand voltage:** up to 2 kV acc. to EOS/ESD-5.1-1993

#### Applications

- outdoor displays
- optical indicators
- backlighting (LCD, switches, keys, displays, illuminated advertising, general lighting)
- interior automotive lighting (e.g. dashboard backlighting, etc.)
- marker lights (e.g. steps, exit ways, etc.)
- signal and symbol luminaire

Typ	Emissions- farbe	Farbe der Lichtaustritts- fläche	Lichtstärke	Lichtstrom	Bestellnummer
Type	Color of Emission	Color of the Light Emitting Area	Luminous Intensity $I_F = 20 \text{ mA}$ $I_V (\text{mcd})$	Luminous Flux $I_F = 20 \text{ mA}$ $\Phi_V (\text{lm})$	Ordering Code
LB M673-M2N2-35	blue	colorless clear	22.4 ... 45.0	100 (typ.)	Q65110A0543
LB M673-N2Q1-35			35.5 ... 90.0	180 (typ.)	Q65110A0544
■ LV M673-P2Q2-35	verde	colorless clear	56 ... 112	240 (typ.)	Q62703Q4847
■ LV M673-Q2S1-35			90 ... 224	440 (typ.)	Q62703Q4893
LT M673-Q1R1-35	true green	colorless clear	71 ... 140	310 (typ.)	Q62703Q4853
LT M673-R1S2-35			112 ... 280	560 (typ.)	Q62703Q4897

■ Nicht für Neuentwicklungen / Not for New Designs

Anm.: -35 gesamter Farbbereich, Lieferung in Einzelgruppen (siehe **Seite 5**)

*Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe, die aus nur 3 bzw. 4 Halbgruppen besteht. Einzelne Halbgruppen sind nicht erhältlich.  
In einer Verpackungseinheit / Gurt ist immer nur eine Halbgruppe enthalten.*

Note: -35 Total color tolerance range, delivery in single groups (please see **page 5**)

*The standard shipping format for serial types includes a lower or upper family group of 3 or 4 individual groups. Individual half groups are not available.  
No packing unit / tape ever contains more than one luminous intensity half group.*

**Grenzwerte**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Werte Values		Einheit Unit
		LB	LV, LT	
Betriebstemperatur Operating temperature range	$T_{op}$	– 40 ... + 100		°C
Lagertemperatur Storage temperature range	$T_{stg}$	– 40 ... + 100		°C
Sperrschichttemperatur Junction temperature	$T_j$	+ 110	+ 125	°C
Durchlassstrom Forward current	$I_F$	20		mA
Stoßstrom Surge current $t \leq 10 \mu s, D = 0.005$	$I_{FM}$	200	250	A
Sperrspannung <sup>1)</sup> Reverse voltage	$V_R$	5		V
Leistungsaufnahme Power consumption $T_A \leq 25 \text{ °C}$	$P_{tot}$	80		mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/ambient Sperrschicht/Lötpad Junction/solder point Montage auf PC-Board FR 4 (Padgröße $\geq 5 \text{ mm}^2$ ) mounted on PC board FR 4 (pad size $\geq 5 \text{ mm}^2$ )	$R_{th JA}$  $R_{th JS}$	480  230		K/W  K/W

<sup>1)</sup> für kurzzeitigen Betrieb geeignet / suitable for short term application

**Kennwerte** ( $T_A = 25\text{ °C}$ )**Characteristics**

Bezeichnung Parameter	Symbol Symbol	Werte Values			Einheit Unit
		LB	LV	LT	
Wellenlänge des emittierten Lichtes (typ.) Wavelength at peak emission $I_F = 20\text{ mA}$	$\lambda_{\text{peak}}$	465	503	523	nm
Dominantwellenlänge <sup>1)</sup> (typ.) Dominant wavelength $I_F = 20\text{ mA}$	$\lambda_{\text{dom}}$	470 $\pm 6$	505 $\pm 7$	528 $\pm 9$	nm
Spektrale Bandbreite bei 50 % $I_{\text{rel max}}$ (typ.) Spectral bandwidth at 50 % $I_{\text{rel max}}$ $I_F = 20\text{ mA}$	$\Delta\lambda$	25	30	33	nm
Abstrahlwinkel bei 50 % $I_V$ (Vollwinkel) (typ.) Viewing angle at 50 % $I_V$	$2\phi$	120	120	120	Grad deg.
Durchlassspannung <sup>2)</sup> (min.) Forward voltage (typ.) $I_F = 20\text{ mA}$ (max.)	$V_F$	2.9	2.9	2.9	V
	$V_F$	3.5	3.3	3.3	V
	$V_F$	3.9	3.9	3.9	V
Sperrstrom (typ.) Reverse current (max.) $V_R = 5\text{ V}$	$I_R$	0.01	0.01	0.01	$\mu\text{A}$
	$I_R$	10	10	10	$\mu\text{A}$
Temperaturkoeffizient von $\lambda_{\text{peak}}$ (typ.) Temperature coefficient of $\lambda_{\text{peak}}$ $I_F = 20\text{ mA}; -10^\circ\text{C} \leq T \leq 100^\circ\text{C}$	$TC_{\lambda_{\text{peak}}}$	0.04	0.03	0.04	nm/K
Temperaturkoeffizient von $\lambda_{\text{dom}}$ (typ.) Temperature coefficient of $\lambda_{\text{dom}}$ $I_F = 20\text{ mA}; -10^\circ\text{C} \leq T \leq 100^\circ\text{C}$	$TC_{\lambda_{\text{dom}}}$	0.03	0.04	0.04	nm/K
Temperaturkoeffizient von $V_F$ (typ.) Temperature coefficient of $V_F$ $I_F = 20\text{ mA}; -10^\circ\text{C} \leq T \leq 100^\circ\text{C}$	$TC_V$	- 4.5	- 3.6	- 3.6	mV/K
Optischer Wirkungsgrad (typ.) Optical efficiency $I_F = 20\text{ mA}$	$\eta_{\text{opt}}$	2	6	8	lm/W

<sup>1)</sup> Wellenlängengruppen werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 1\text{ nm}$  ermittelt.  
Wavelength groups are tested at a current pulse duration of 25 ms and a tolerance of  $\pm 1\text{ nm}$ .

<sup>2)</sup> Durchlassspannungsguppen werden mit einer Stromeinprägedauer von 1 ms und einer Genauigkeit von  $\pm 0,05\text{ V}$  ermittelt.  
Forward voltage groups are tested at a current pulse duration of 1 ms and a tolerance of  $\pm 0.05\text{ V}$ .

## 1) Wellenlängengruppen / Wavelength groups

Gruppe Group	blue		verde		true green		Einheit Unit
	min.	max.	min.	max.	min.	max.	
3	464	468	498	503	519	525	nm
4	468	472	503	507	525	531	nm
5	472	476	507	512	531	537	nm

**Helligkeits-Gruppierungsschema**  
**Luminous Intensity Groups**

Lichtgruppe Luminous Intensity Group	Lichtstärke Luminous Intensity $I_V$ (mcd)	Lichtstrom Luminous Flux $\Phi_V$ (lm)
M2	22.4 ... 28.0	75 (typ.)
N1	28.0 ... 35.5	95 (typ.)
N2	35.5 ... 45.0	120 (typ.)
P1	45.0 ... 56.0	150 (typ.)
P2	56.0 ... 71.0	190 (typ.)
Q1	71.0 ... 90.0	240 (typ.)
Q2	90.0 ... 112.0	300 (typ.)
R1	112.0 ... 140.0	380 (typ.)
R2	140.0 ... 180.0	480 (typ.)
S1	180.0 ... 224.0	600 (typ.)
S2	224.0 ... 280.0	760 (typ.)

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 11\%$  ermittelt.  
 Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of  $\pm 11\%$ .

**Gruppenbezeichnung auf Etikett**  
**Group Name on Label**

Beispiel: S2-3

Example: S2-3

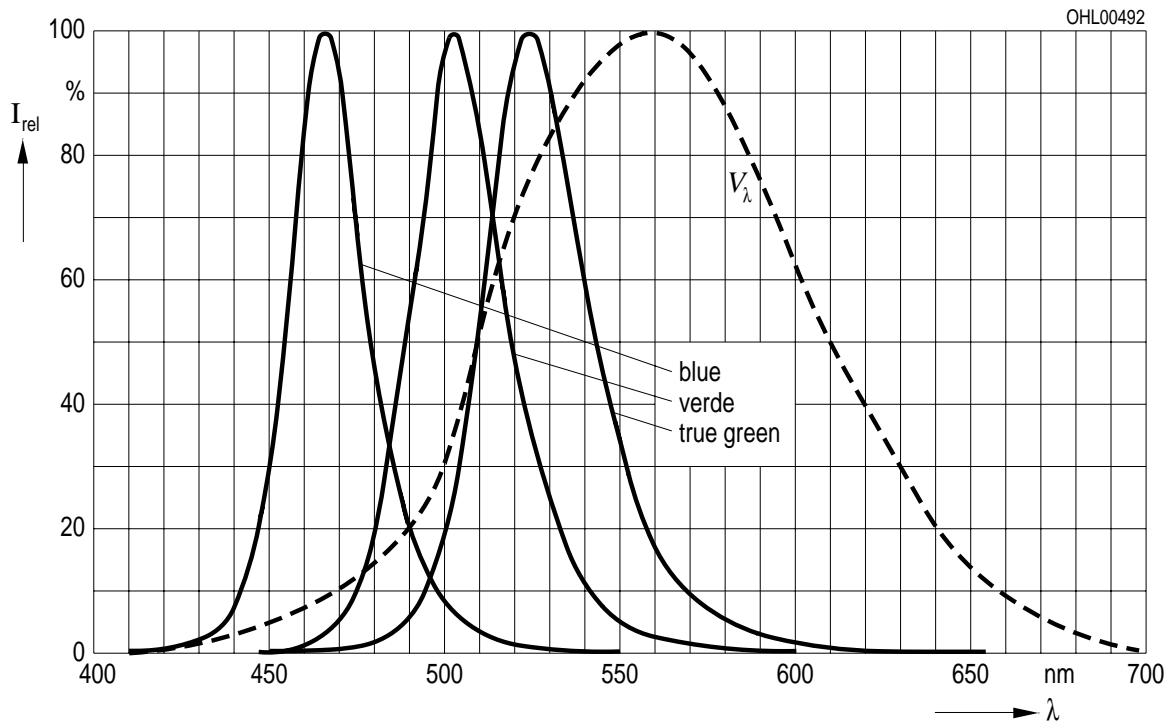
Lichtgruppe Luminous Intensity Group	Halbgruppe Half Group	Wellenlänge Wavelength
S	2	3

**Relative spektrale Emission**  $I_{\text{rel}} = f(\lambda)$ ,  $T_A = 25^\circ\text{C}$ ,  $I_F = 20\text{ mA}$

### Relative Spectral Emission

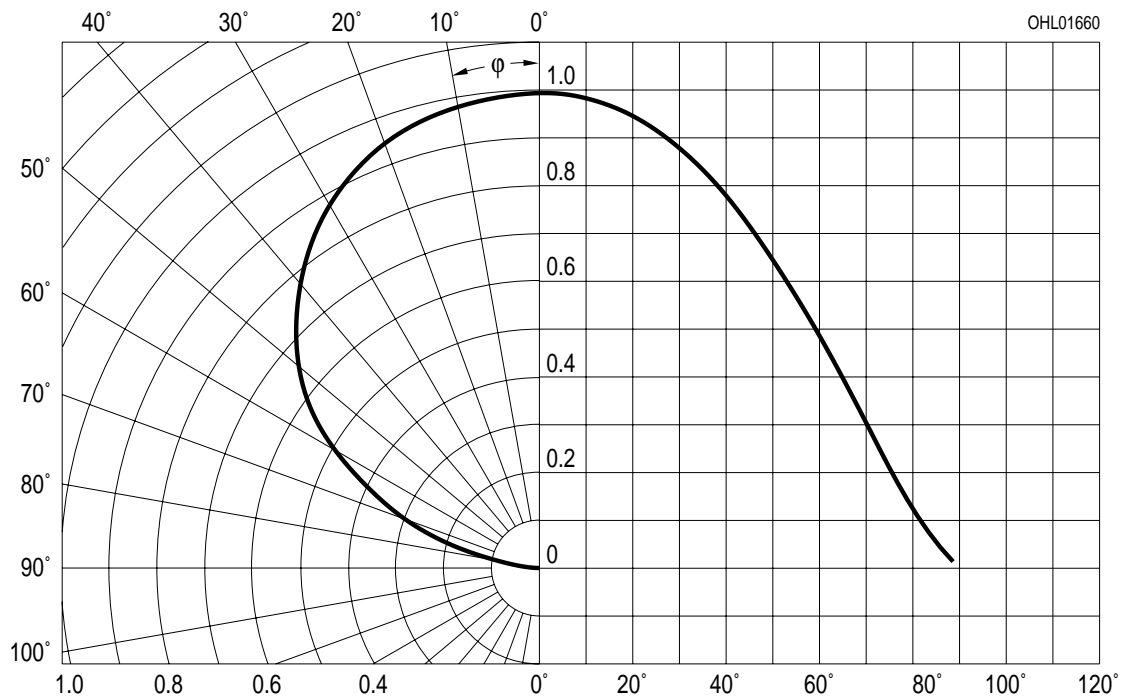
$V(\lambda)$  = spektrale Augenempfindlichkeit

Standard eye response curve



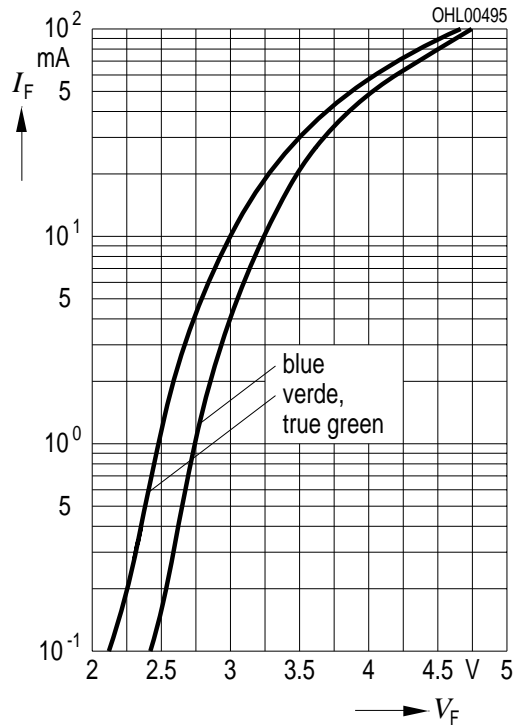
**Abstrahlcharakteristik**  $I_{\text{rel}} = f(\varphi)$

### Radiation Characteristic



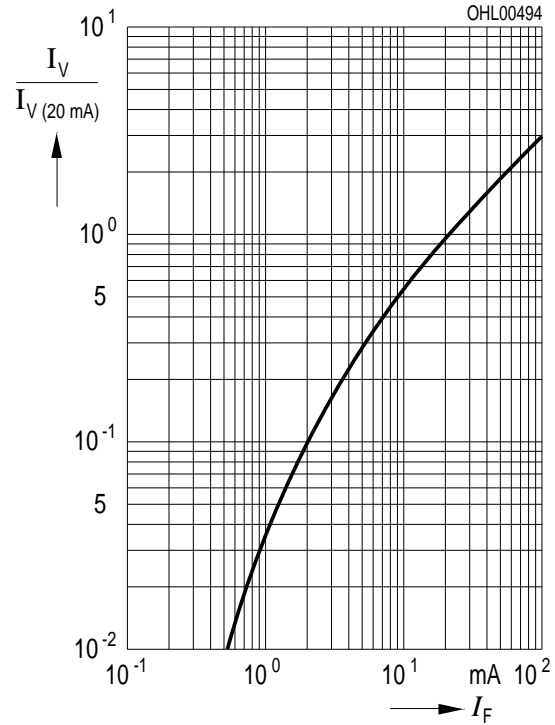
**Durchlassstrom  $I_F = f(V_F)$**   
**Forward Current**

$T_A = 25\text{ °C}$

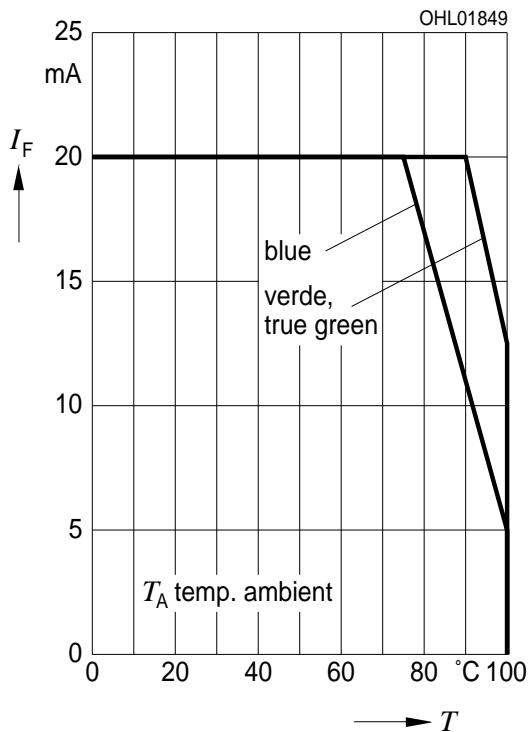


**Relative Lichtstärke  $I_V/I_{V(20\text{ mA})} = f(I_F)$**   
**Relative Luminous Intensity**

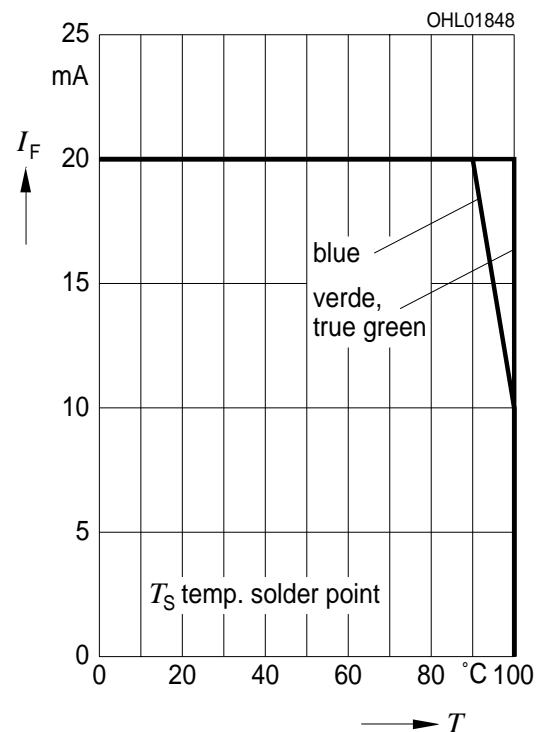
$T_A = 25\text{ °C}$



**Maximal zulässiger Durchlassstrom  $I_F = f(T)$**   
**Max. Permissible Forward Current**



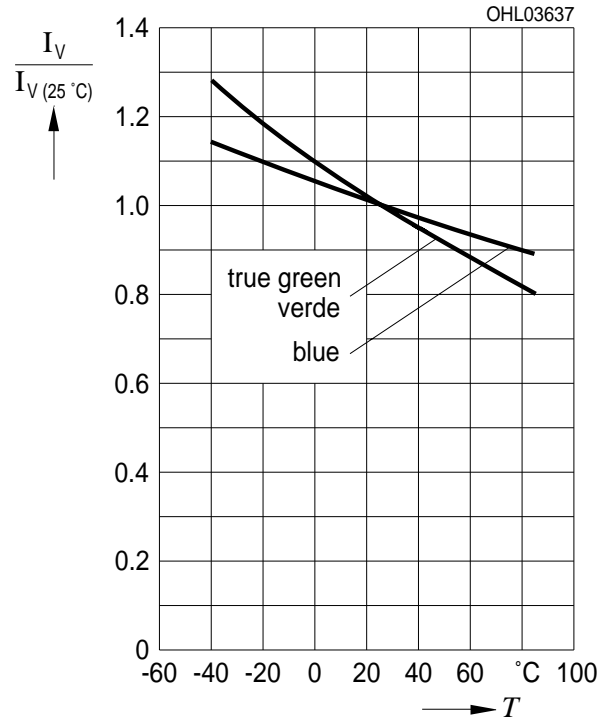
**Maximal zulässiger Durchlassstrom  $I_F = f(T)$**   
**Max. Permissible Forward Current**



Relative Lichtstärke  $I_V/I_{V(25\text{ °C})} = f(T_A)$

Relative Luminous Intensity

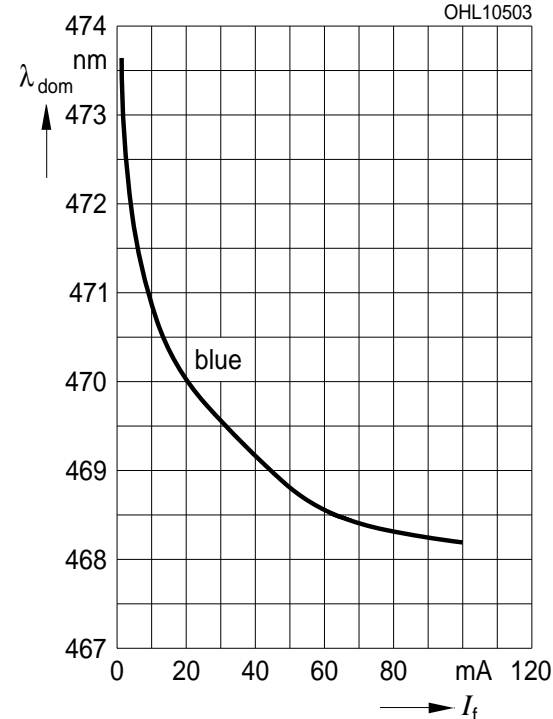
$I_F = 20\text{ mA}$



Dominante Wellenlänge  $\lambda_{\text{dom}} = f(I_F)$

Dominant Wavelength

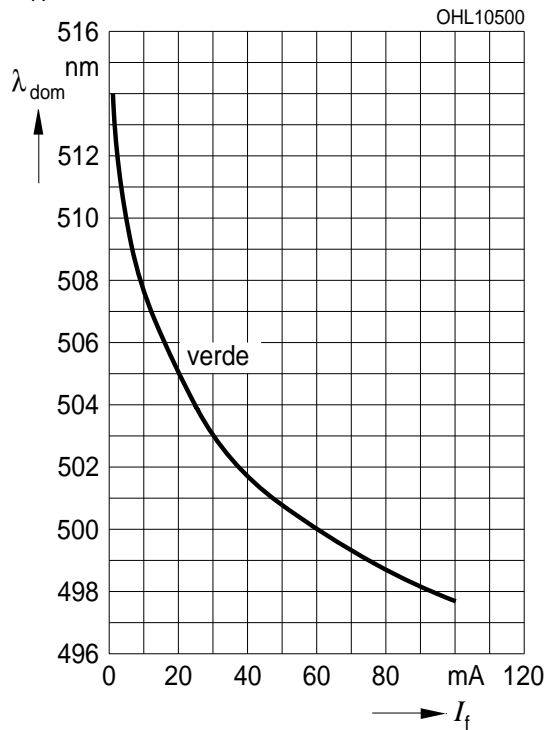
LB,  $T_A = 25\text{ °C}$



Dominante Wellenlänge  $\lambda_{\text{dom}} = f(I_F)$

Dominant Wavelength

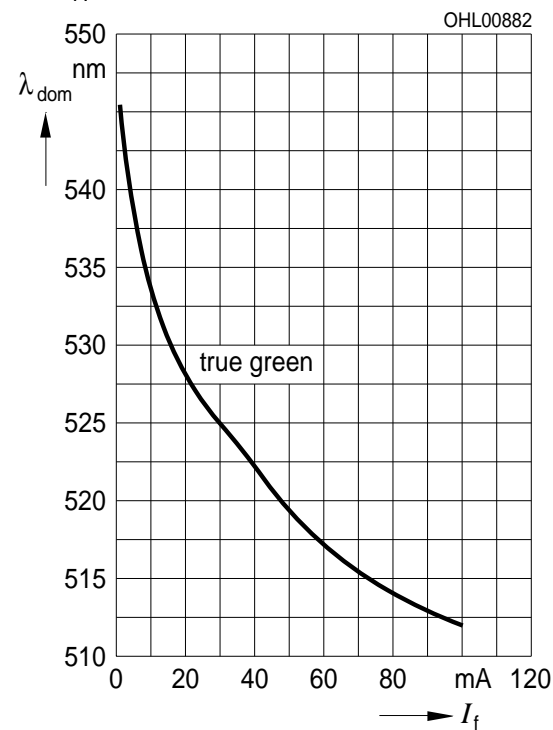
LV,  $T_A = 25\text{ °C}$



Dominante Wellenlänge  $\lambda_{\text{dom}} = f(I_F)$

Dominant Wavelength

LT,  $T_A = 25\text{ °C}$



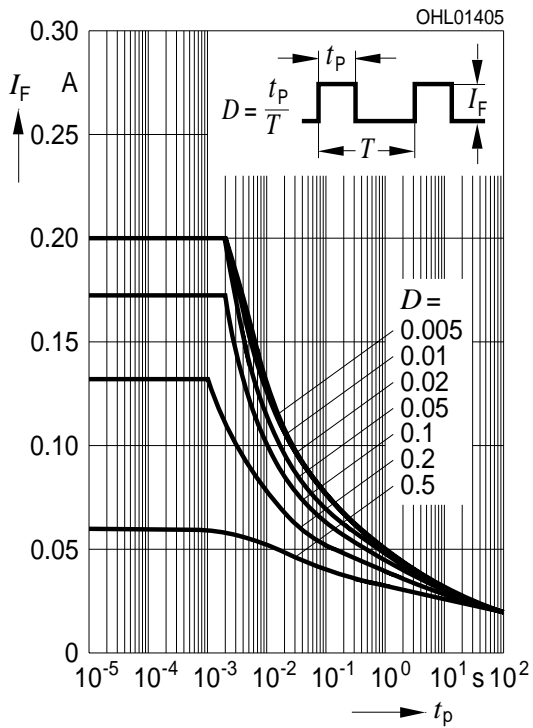


Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$

Permissible Pulse Handling Capability

Duty cycle  $D =$  parameter,  $T_A = 25\text{ °C}$

LB

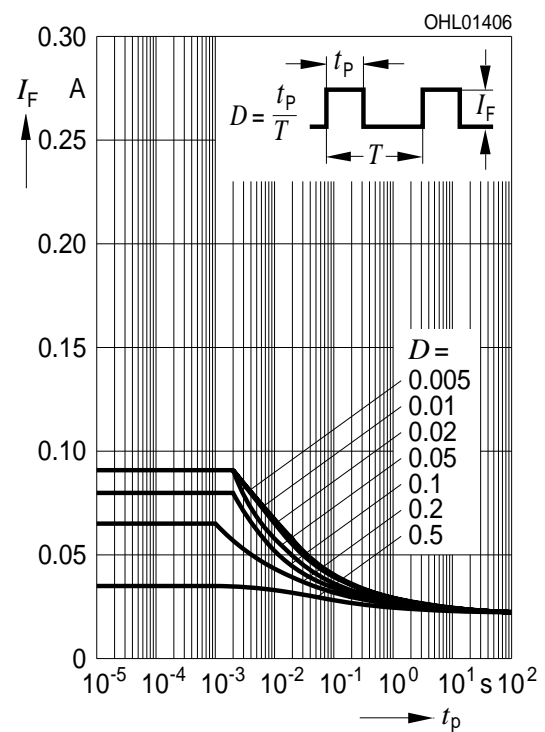


Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$

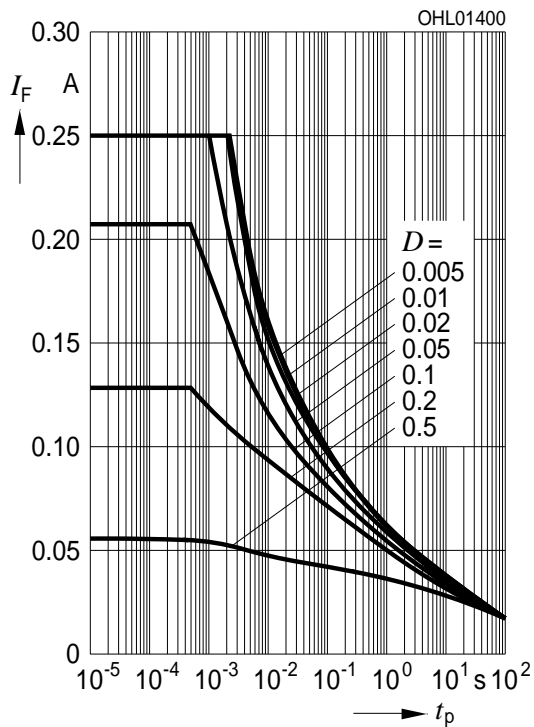
Permissible Pulse Handling Capability

Duty cycle  $D =$  parameter,  $T_A = 85\text{ °C}$

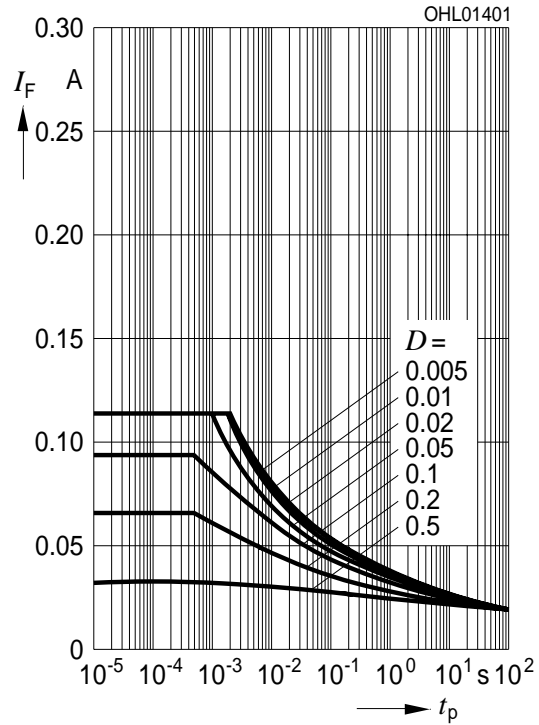
LB



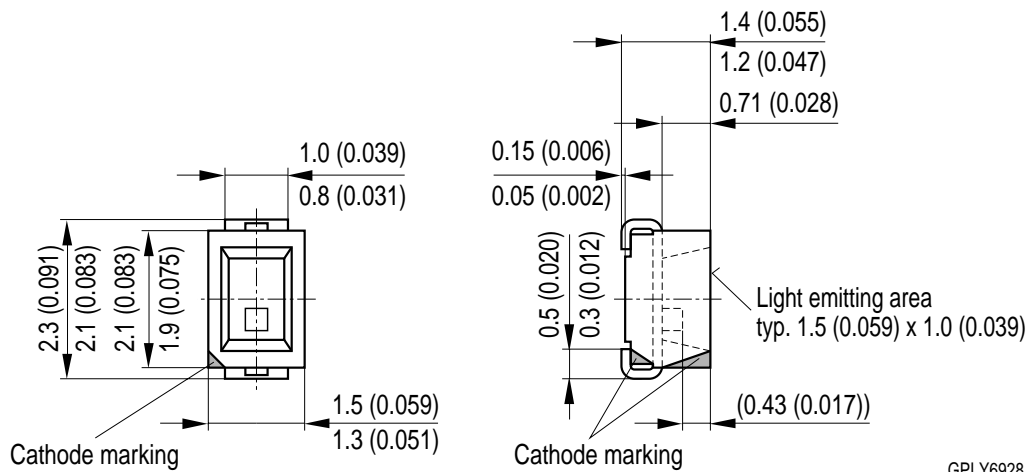
**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D = \text{parameter}$ ,  $T_A = 25\text{ °C}$   
**LV, LT**



**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D = \text{parameter}$ ,  $T_A = 85\text{ °C}$   
**LV, LT**



# **Maßzeichnung** **Package Outlines**

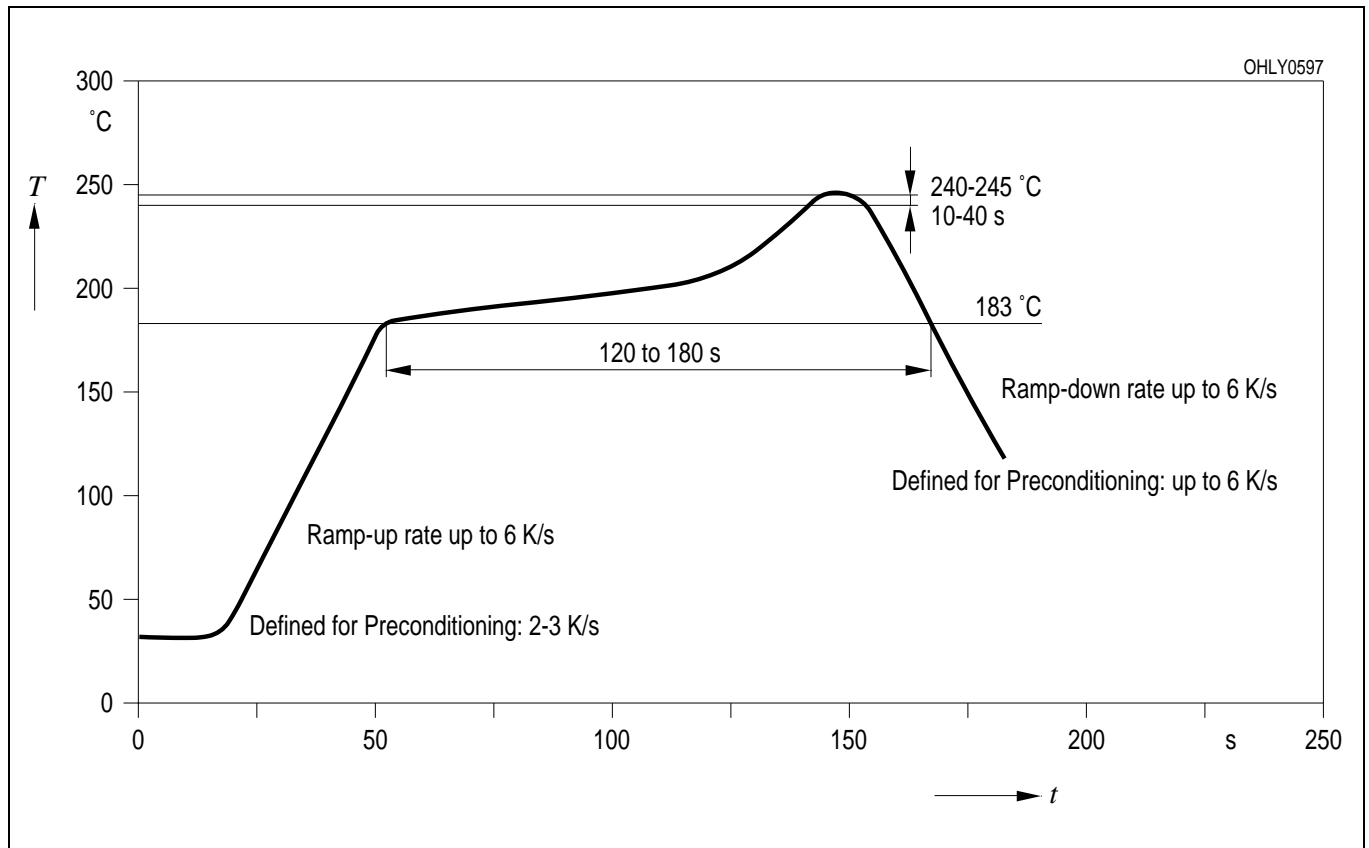


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

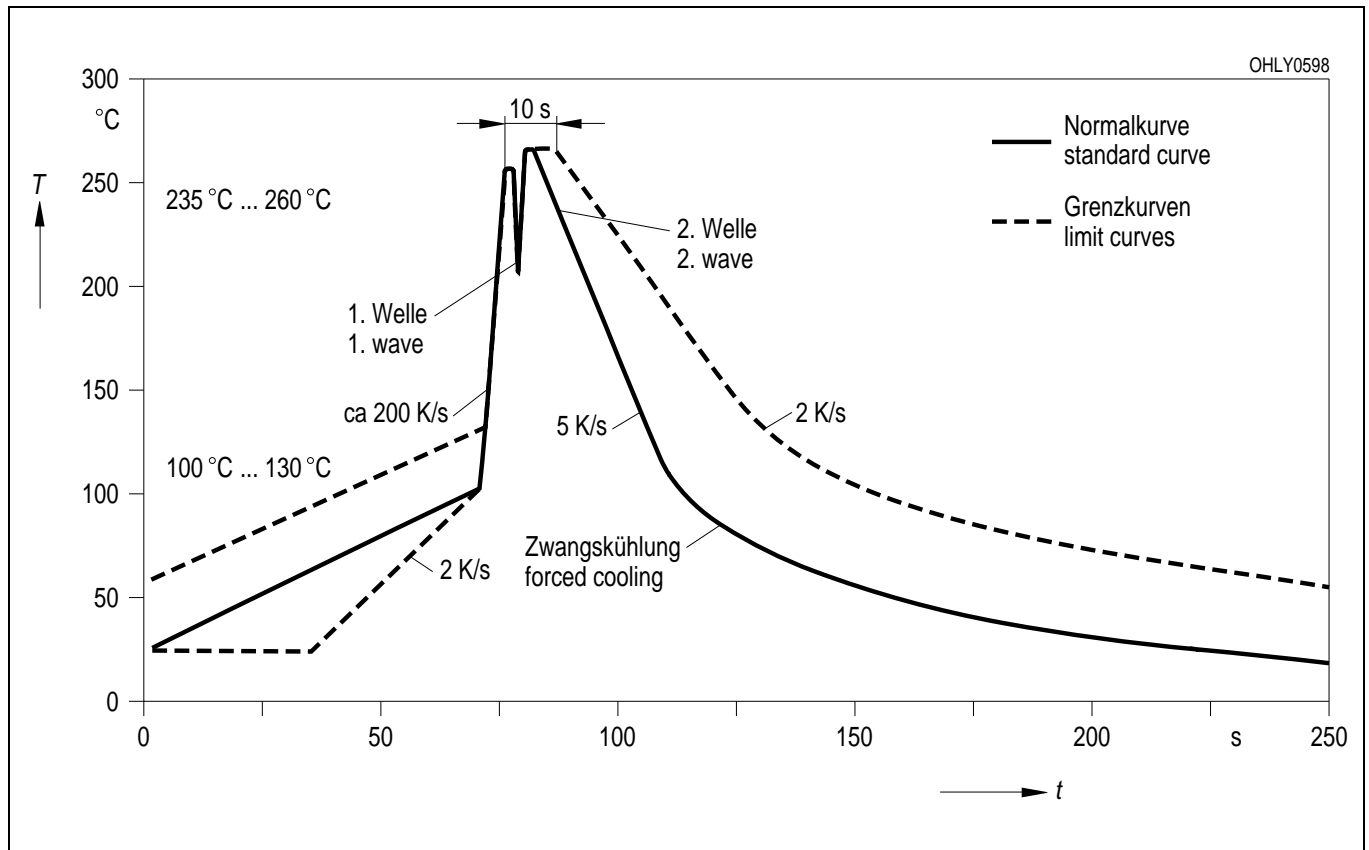
**Kathodenkennung:** abgeschrägte Ecke  
**Cathode mark:** bevelled edge  
**Gewicht / Approx. weight:** 10 mg

**Lötbedingungen** Vorbehandlung nach JEDEC Level 2  
**Soldering Conditions** Preconditioning acc. to JEDEC Level 2

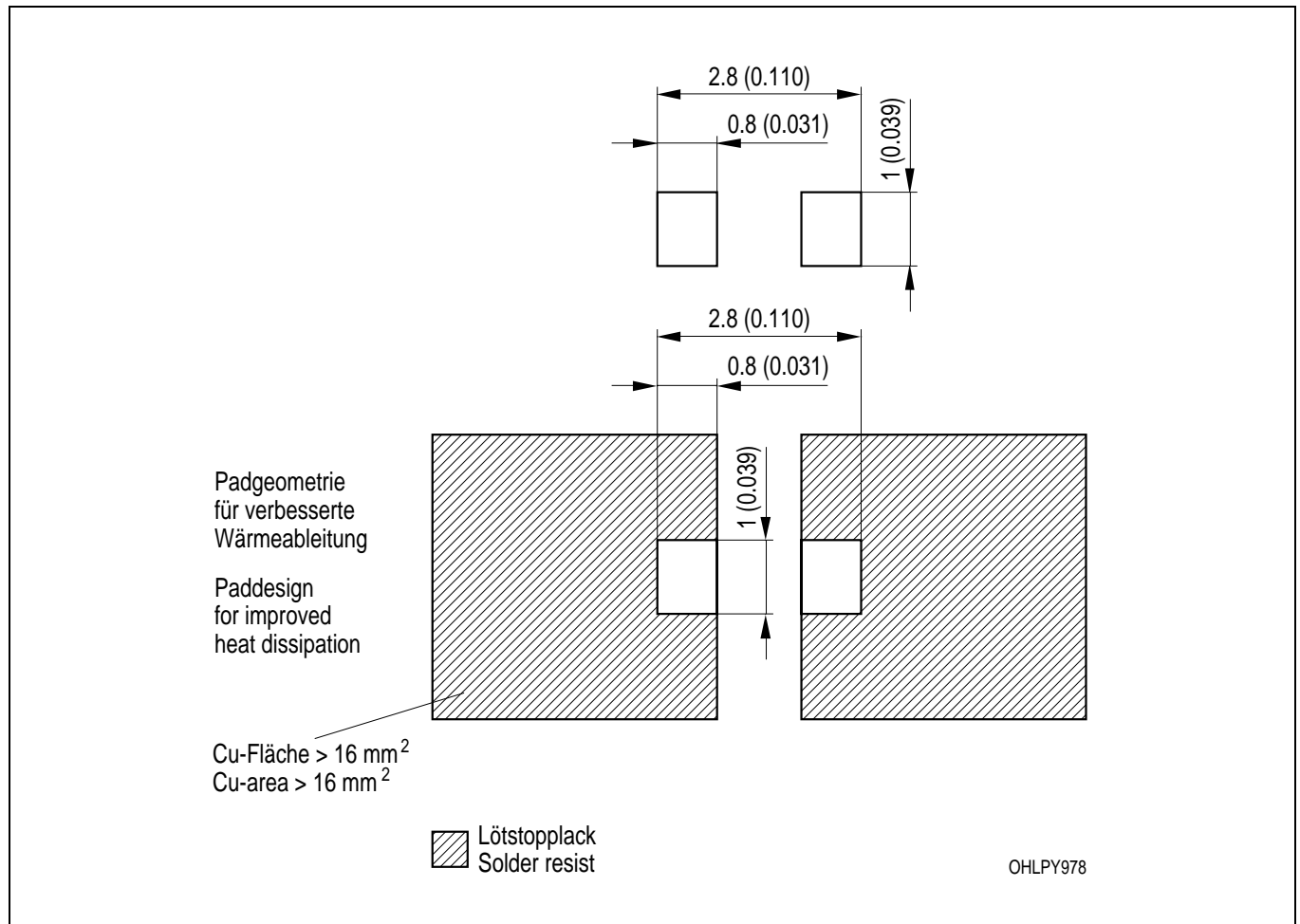
**IR-Reflow Lötprofil** (nach IPC 9501)  
**IR Reflow Soldering Profile** (acc. to IPC 9501)



**Wellenlöten (TTW)** (nach CECC 00802)  
**TTW Soldering** (acc. to CECC 00802)



**Empfohlenes Lötpaddesign** IR Reflow Löten  
**Recommended Solder Pad** IR Reflow Soldering



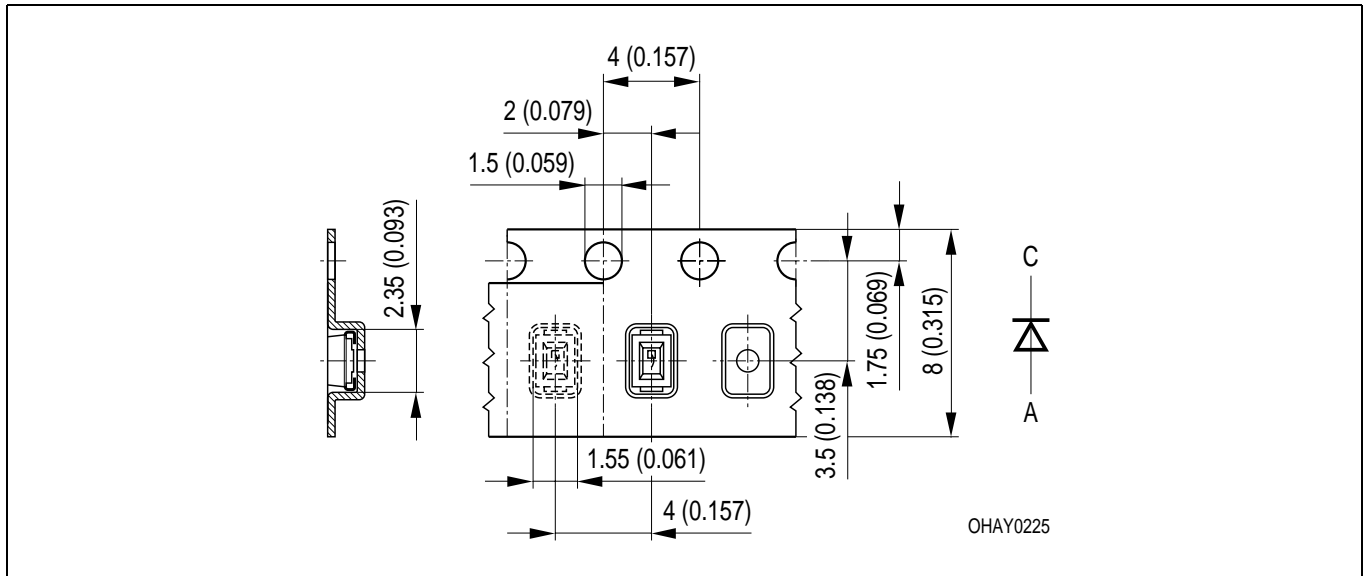
Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).  
 Gehäuse hält TTW-Löthitze aus / Package able to withstand TTW-soldering heat

**Gurtung / Polarität und Lage**

Verpackungseinheit 3000/Rolle,  $\varnothing 180$  mm  
oder 12000/Rolle,  $\varnothing 330$  mm

**Method of Taping / Polarity and Orientation**

Packing unit 3000/reel,  $\varnothing 180$  mm  
or 12000/reel,  $\varnothing 330$  mm



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Revision History: 2003-06-16		Date of change
Previous Version: 2003-04-14		
Page	Subjects (major changes since last revision)	
4	value (forward voltage)	
3	power consumption from 85 mW to 80 mW	
5	wavelength groups	
8	diagram max. permissible forward current to OHL01573 and OHL 11574	
2	wavelength grouping for blue, true green and verde	
3	pad size from 16 mm <sup>2</sup> to 5 mm <sup>2</sup>	
16	annotations	2002-07-23
3	reverse voltage (footnote)	2002-08-21
2	new luminous intensity groups for LB M673	2003-03-11
4	values (temperature coefficient of $\lambda_{\text{dom}}$ and $V_F$ )	2003-04-14
7	diagrams max. perm. forward current	2003-06-16

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#### **Attention please!**

The information describes the type of component and shall not be considered as assured characteristics. All typical data and graphs are basing on representative samples, but don't represent the production range. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances. For information on the types in question please contact our Sales Organization. If printed or downloaded, please find the latest version in the Internet.

#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

**Components used in life-support devices or systems must be expressly authorized for such purpose!** Critical components <sup>1</sup> may only be used in life-support devices or systems <sup>2</sup> with the express written approval of OSRAM OS.

<sup>1</sup> A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

<sup>2</sup> Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered.